

QUICKSWITCH[®] PRODUCTS 2.5V / 3.3V 8-BIT HIGH BANDWIDTH BUS SWITCH

FEATURES:

- N channel FET switches with no parasitic diode to Vcc
 - Isolation under power-off conditions
 - No DC path to Vcc or GND
 - 5V tolerant in OFF and ON state
- 5V tolerant I/Os
- Flat Ron characteristics over operating range
- Rail-to-rail switching 0 5V
- Bidirectional dataflow with near-zero delay: no added ground bounce
- Excellent Ron matching between channels
- Vcc operation: 2.3V to 3.6V
- · High bandwidth
- LVTTL-compatible control Inputs
- Undershoot Clamp Diodes on all switch and control Inputs
- · Low I/O capacitance, 4pF typical
- 25Ω resistors for low noise and line matching
- Available in QSOP and TSSOP packages

APPLICATIONS:

- Hot-swapping
- Low distortion analog switch
- · Replaces mechanical relay
- ATM 25/155 switching

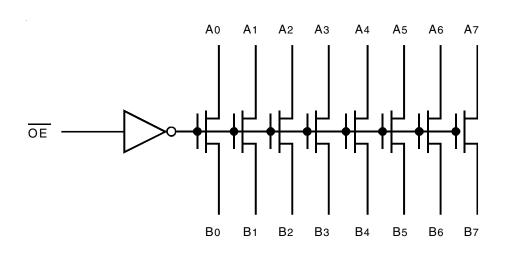
FUNCTIONAL BLOCK DIAGRAM

DESCRIPTION:

The QS3VH2245 is a high bandwidth 8-bit bus switch. The QS3VH2245, with 25Ω ON resistance and 1.35ns propagation delay, is ideal for line matching and low noise environments. The switches can be turned ON under the control of the LVTTL-compatible Output Enable signal for bidirectional data flow with no added delay or ground bounce. In the ON state, the switches can pass signals up to 5V. In the OFF state, the switches offer very high impedence at the terminals.

The combination of small propagation delay, high OFF impedance, and over-voltage tolerance makes the QS3VH2245 ideal for high performance communication applications.

The QS3VH2245 is characterized for operation from -40°C to +85°C.

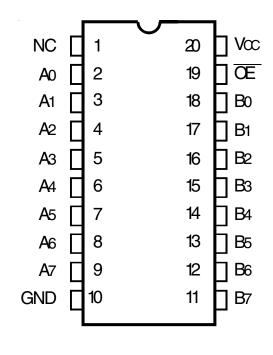


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INDUSTRIAL TEMPERATURE RANGE

FEBRUARY 2014

PIN CONFIGURATION



QSOP/ TSSOP TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM ⁽²⁾	SupplyVoltage to Ground	-0.5 to +4.6	V
VTERM ⁽³⁾	DC Switch Voltage Vs	-0.5 to +5.5	V
VTERM ⁽³⁾	DC Input Voltage VIN	-0.5 to +5.5	V
VAC	AC Input Voltage (pulse width ≤20ns)	-3	V
Ιουτ	DC Output Current (max. sink current/pin) 120		mA
Tstg	Storage Temperature	–65 to +150	°C

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc terminals.

3. All terminals except Vcc .

CAPACITANCE (TA = +25°C, F = 1MHz, VIN = 0V, VOUT =

0 Sy mbol	Parameter ⁽¹⁾	Тур.	Max.	Unit
CIN	Control Inputs	3	5	pF
CI/O	Quickswitch Channels (Switch OFF)	4	6	pF
CI/O	Quickswitch Channels (Switch ON)	8	12	pF

NOTE:

1. This parameter is guaranteed but not production tested.

PIN DESCRIPTION

Pin Names	Description	
ŌĒ	Output Enable	
Ax	Data I/Os	
Bx	Data I/Os	

FUNCTION TABLE⁽¹⁾

ŌĒ	Function
Н	Disconnected
L	Connect (Ax = Bx)

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40°C to +85°C, Vcc = $3.3V \pm 0.3V$

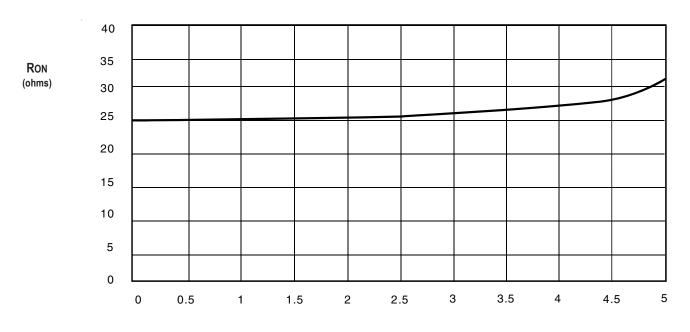
Symbol	Parameter	Test C	Conditions		Min.	Typ. ⁽¹⁾	Max.	Unit
Vih	Input HIGH Voltage	Guaranteed Logic HIGH	Vcc = 2.3V to 2.7	Ϋ́V	1.7	—	—	V
		for Control Inputs	Vcc = 2.7V to 3.6	νV	2	-	_	
VIL	Input LOW Voltage	Guaranteed Logic LOW	Vcc = 2.3V to 2.7	Ϋ́V	_	—	0.7	V
		for Control Inputs	Vcc = 2.7V to 3.6	νV	—	_	0.8	
lin	Input Leakage Current (Control Inputs)	$0V \le VIN \le VCC$		_	—	±1	μA	
loz	Off-State Current (Hi-Z)	$0V \le VOUT \le 5V$, Switches OFF		—	_	±1	μA	
IOFF	Data Input/Output Power Off Leakage	VIN or VOUT 0V to 5V, VCC = 0V			_	—	±1	μA
		Vcc = 2.3V	VIN = 0V	Ion = 30mA	18	27	39	
Ron	Switch ON Resistance	Typical at Vcc = 2.5V	VIN = 1.7V	Ion = 15mA	18	28	41	Ω
		Vcc = 3V	VIN = 0V	Ion = 30mA	18	25	38	
			VIN = 2.4V	Ion = 15mA	18	26	40	1

INDUSTRIAL TEMPERATURE RANGI

NOTE:

1. Typical values are at Vcc = 3.3V and TA = 25°C.

TYPICAL ON RESISTANCE vs Vin AT Vcc = 3.3V



VIN (Volts)

POWER SUPPLY CHARACTERISTICS

53VH2245 3.3V 8-BIT HIGH BANDWIDTH BUS SWITCH

Symbol	Parameter	Test Conditions ⁽¹⁾	Min.	Тур.	Max.	Unit
lccq	Quiescent Power Supply Current	Vcc = Max., VIN = GND or Vcc, f = 0		2	4	mA
Δ lcc	Power Supply Current (2.3) per Input HIGH	Vcc = Max., VIN = 3V, f = 0 per Control Input	_	—	30	μA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = 3.3V, A and B Pins Open, Control Inputs Toggling @ 50% Duty Cycle	See Typical	ICCD vs Enab	le Frequency	graph below

NOTES:

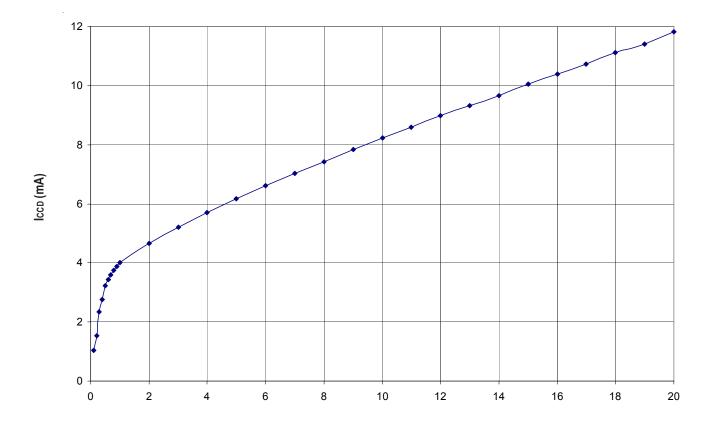
1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.

2. Per input driven at the specified level. A and B pins do not contribute to Δ Icc.

3. This parameter is guaranteed but not tested.

4. This parameter represents the current required to switch internal capacitance at the specified frequency. The A and B inputs do not contribute to the Dynamic Power Supply Current. This parameter is guaranteed but not production tested.

TYPICAL ICCD vs ENABLE FREQUENCY CURVE AT VCC = 3.3V



ENABLE FREQUENCY (MHz)

T_A = -40°C to +85°C

		$Vcc = 2.5 \pm 0.2V^{(1)}$		$Vcc = 3.3 \pm 0.3 V^{(1)}$		
Symbol	Parameter	Min. ⁽⁴⁾	Max.	Min. ⁽⁴⁾	Max.	Unit
tPLH .	Data Propagation Delay ^(2,3)		0.9	—	1.35	ns
t PHL	Ax to/from Bx					
tPZL	Switch Turn-On Delay	1.5	9	1.5	8	ns
tрzн	OE to Ax/Bx					
tPLZ	Switch Turn-Off Delay	1.5	7.5	1.5	7.5	ns
tPHZ	OE to Ax/Bx					
foe	Operating Frequency - Enable, Select ^(2,5)		10	—	20	MHz

INDUSTRIAL TEMPERATURE RANG

NOTES:

1. See Test Conditions under TEST CIRCUITS AND WAVEFORMS.

2. This parameter is guaranteed but not production tested.

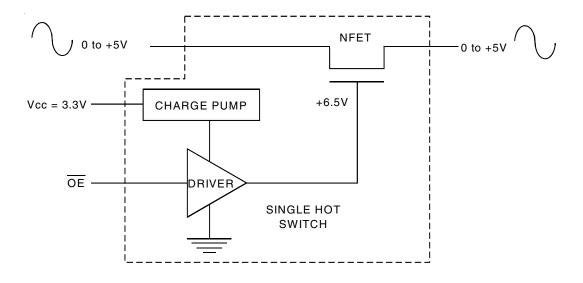
3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 1.35ns at CL = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

4. Minimums are guaranteed but not production tested.

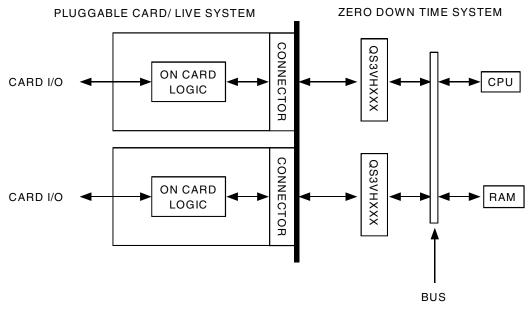
5. Maximum toggle frequency for \overline{OE} control input (pass voltage > Vcc, VIN = 5V, RLOAD $\ge 1M\Omega$, no CLOAD).

SOME APPLICATIONS FOR HOTSWITCH PRODUCTS

S3VH2245 3 3V 8-BIT HIGH BANDWIDTH BUS SWITCH



Rail-to-Rail Switching



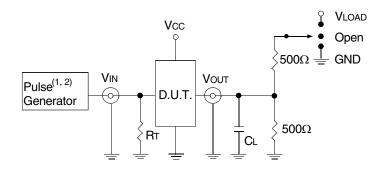
Hot-Swapping

TEST CIRCUITS AND WAVEFORMS

BIT HIGH BANDWIDTH BUS SWITCH

TEST CONDITIONS

Symbol	$Vcc^{(1)}= 3.3V \pm 0.3V$	$Vcc^{(2)} = 2.5V \pm 0.2V$	Unit
Vload	6	2 x Vcc	V
Vih	3	Vcc	V
Vt	1.5	Vcc/2	V
Vlz	300	150	mV
VHZ	300	150	mV
CL	50	30	pF



Test Circuits for All Outputs

DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

 $\mathsf{R} \mathsf{T}$ = Termination resistance: should be equal to $\mathsf{Z} \mathsf{O} \mathsf{U} \mathsf{T}$ of the Pulse Generator.

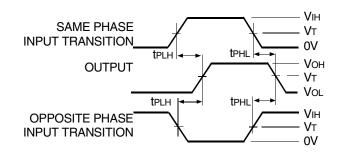
NOTES:

1. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2.5ns; tR \leq 2.5ns.

2. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2ns; tR \leq 2ns.

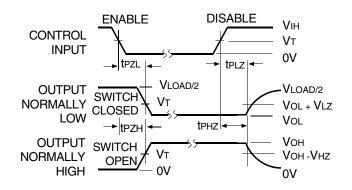
SWITCH POSITION

Test	Switch
tplz/tpzl	Vload
tphz/tpzh	GND
tPD	Open



INDUSTRIAL TEMPERATURE RANG

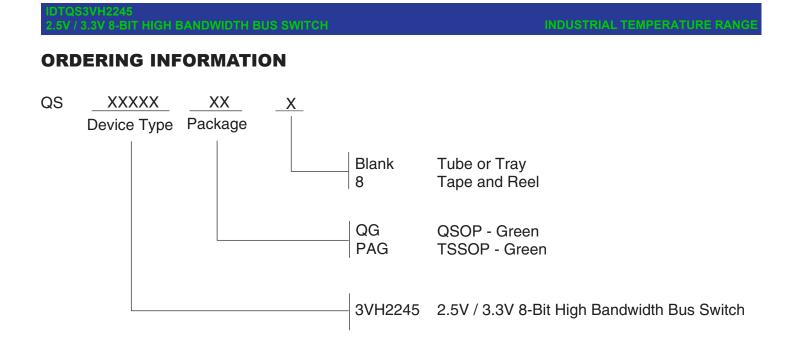
Propagation Delay



NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

Enable and Disable Times



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